

## 2.7GHz UpConverter with Gain Control



The HFA3664 UpConverter with Gain Control is a monolithic bipolar PRISM® device for up conversion applications in the 2.3GHz to 2.7GHz range.

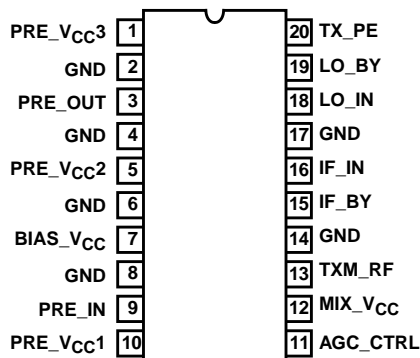
Manufactured in the Intersil UHF1X process, the device consists of a double balanced mixer followed by a variable gain power preamp. An energy saving, TTL Compatible, power enable input provides on/off bias current control to the mixer and amplifier. The device requires low drive levels from the local oscillator and is housed in a small outline 20 lead SSOP package ideally suited for PCMCIA card applications.

## Ordering Information

PART NUMBER	TEMP. RANGE (°C)	PACKAGE	PKG. NO.
HFA3664IA	-40 to 85	20 Ld SSOP	M20.15
HFA3664IA96	-40 to 85	Tape and Reel	

## Pinout

**HFA3664  
(SSOP)  
TOP VIEW**



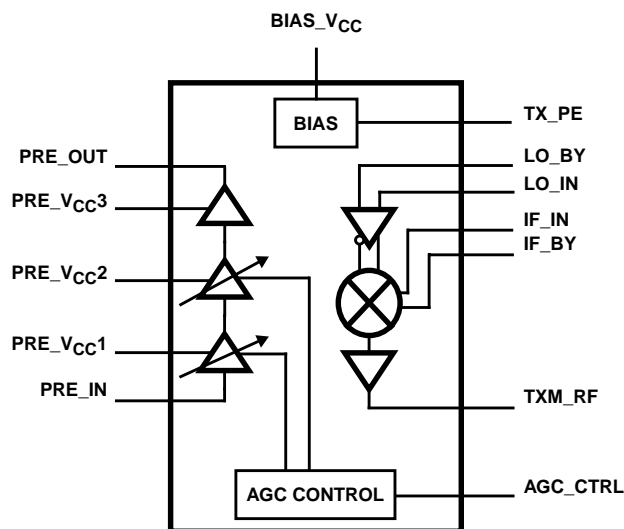
## Features

- RF Frequency Range . . . . . 2.3GHz to 2.7GHz
- IF Operation . . . . . 10MHz to 400MHz
- Gain Control Range . . . . . 20dB
- Single Supply Operation. . . . . 2.7V to 5.5V
- High Output 1dB Compression. . . . . 6dBm
- High Power Gain . . . . . 18dB
- Power Enable/Disable Control

## Applications

- Wireless Local Loop Systems
- PCMCIA Wireless Transceiver
- Wireless Local Area Network Modems
- CDMA/TDMA Packet Protocol Radios
- Full Duplex Transceivers
- Portable Battery Powered Equipment

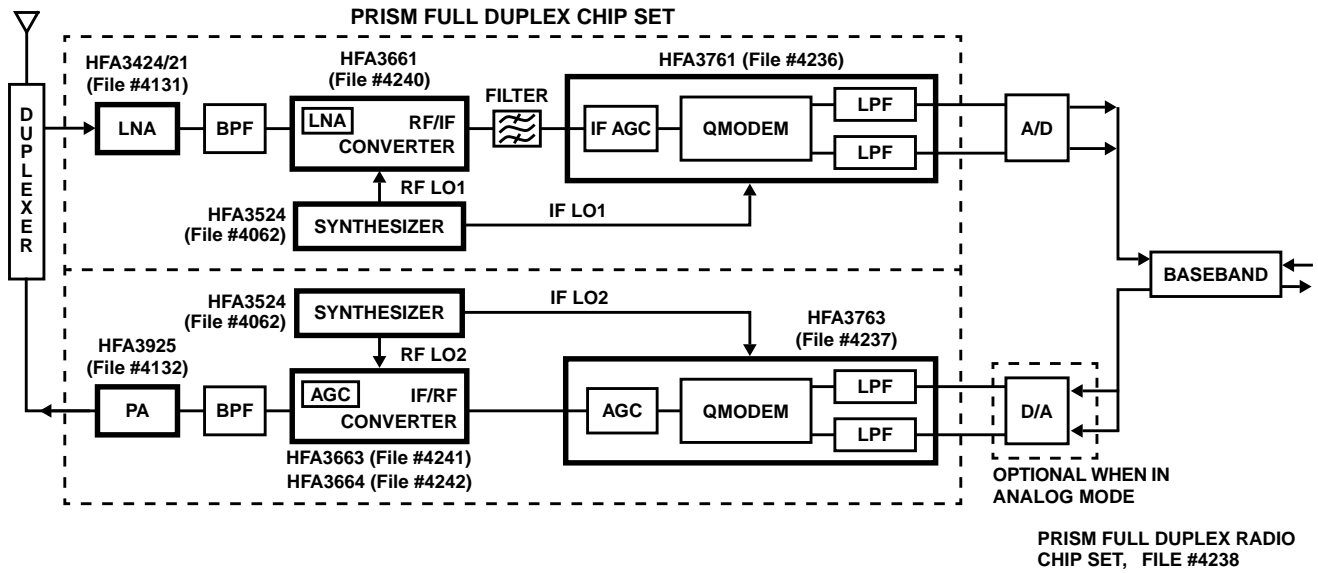
## Block Diagram



**POWER CONTROL TRUTH TABLE**

STATE	TX_PE
Power Down - Energy Saving Mode	Low
Transmit Mode	High

## Typical Application Diagram



## Pin Descriptions

NAME	DESCRIPTION
LO_IN	Local Oscillator Input.
LO_BY	Local Oscillator Input Bypass (AC coupled to GND).
PRE_IN	Power Pre-Amplifier Input.
PRE_OUT	Power Pre-Amplifier Output.
PRE_V <sub>CC</sub> 1	Power Pre-Amplifier 1st Stage Positive Power Supply. Use high quality RF decoupling capacitors.
PRE_V <sub>CC</sub> 2	Power Pre-Amplifier 2nd Stage Positive Power Supply. Use high quality RF decoupling capacitors.
PRE_V <sub>CC</sub> 3	Power Pre-Amplifier 3rd Stage Positive Power Supply. Use high quality RF decoupling capacitors.
BIAS_V <sub>CC</sub>	LO Buffer, Bias, Mixer and AGC Control Positive Power Supply. Requires an isolation coil to V <sub>CC</sub> .
MIX_V <sub>CC</sub>	Transmit Mixer Output Stage Positive Power Supply. Use high quality RF decoupling capacitors.
RX_PE	Power Enable Control Input. Refer to the Power Control Truth Table.
TXM_RF	Transmit Mixer RF Output.
IF_IN	Transmit Mixer Positive IF Input. Requires external bias resistor to V <sub>CC</sub> .
IF_BY	Transmit Mixer Negative IF Input (AC coupled to GND).
GND	Circuit Ground Pins (Qty 6). Internally connected with the exception of pin 17.

**Absolute Maximum Ratings**

Supply Voltage . . . . . -0.3 to 6.0V  
 Voltage on Any Other Pin . . . . . -0.3 to  $V_{CC}$  0.3V

**Operating Conditions**

Supply Voltage Range . . . . . 2.7V to 5.5V

**Thermal Information**

Thermal Resistance (Typical, Note 1)  $\theta_{JA}$  (°C/W)  
 20 Lead SSOP . . . . . 110  
 Package Power Dissipation at 70°C  
 20 Lead SSOP . . . . . 0.7W  
 Maximum Junction Temperature (Plastic Package) . . . . . 150°C  
 Maximum Temperature Range . . . . . -40°C  $\leq T_A \leq$  85°C  
 Maximum Storage Temperature Range . . . . . -65°C  $\leq T_A \leq$  150°C  
 Maximum Lead Temperature (Soldering 10s) . . . . . 300°C  
 (Lead Tips Only)

**CAUTION:** Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

**NOTE:**

1.  $\theta_{JA}$  is measured with the component mounted on an evaluation PC board in free air.

**Electrical Specifications**  $V_{CC} = 5.5V$ , LO = 2400MHz, IF = 100MHz, RF = 2500MHz,  $Z_O = 50\Omega$ ,  
 Unless Otherwise Specified

PARAMETER	SYMBOL	(NOTE 2) TEST LEVEL	TEMP (°C)	MIN	TYP	MAX	UNITS
<b>CASCADED CHARACTERISTICS</b> (-3dB Loss RF Image Filter with 35dB LO Suppression, LO_IN = 2400MHz/-6dBm, IF_IN = 100MHz/-30dBm, AGC_CTRL = 0.7V (Max Gain))							
Cascaded Output 1dB Compression	CTX_P1D	B	25	6	7.5	-	dBm
Cascaded Output Third Order Intercept	CTX_IP3	C	25	-	14	-	dBm
Cascaded Power Gain	CTX_PG	B	25	18	23	-	dB
Cascaded Power Gain Flatness (2.3GHz to 2.7GHz)	CTX_PGF	C	25	-2.5	0	+2.5	dB
Cascaded LO Leakage	CTX_LEAK	B	25	-	-23.8	-	dBm
<b>LO INPUT CHARACTERISTICS</b> (LO_IN = 2400MHz/-6dBm, all unused inputs and outputs are terminated into 50 $\Omega$ )							
LO Input Frequency Range	LO_f	B	25	1.9	-	2.29	GHz
LO Input Drive Level	LO_dr	A	25, 85	-	-6	-	dBm
LO Input VSWR	LO_SWR	A	25, 85	1.0:1	1.62:1	2.3:1	-
LO Input Return Loss	LO_IRL	A	25, 85	8.09	12.5	-	dB
<b>TRANSMIT MIXER CHARACTERISTICS</b> (LO_IN = 2400MHz/-6dBm, TXM_IF = 100MHz/-30dBm)							
IF Input Frequency Range	TXM_IFf	B	25, 85	10	-	400	MHz
IF Input VSWR	TXM_SWR	A	25, 85	-	1.22:1	2.0:1	-
IF Input Return Loss	TXM_IRL	A	25, 85	9.5	20	-	dB
Power Conversion Gain (Note 3)	$V_{CC} = 5.5V$ TXM_PGH	A	25, 85	3.0	4.5	TBD	dB
Transmit Mixer LO Leakage	TXM_LEAK	A	25, 85	-	-20	-10	dBm
RF Output Frequency Range	TXM_RFf	B	25, 85	2.4	-	2.7	GHz
RF Output VSWR	TXM_OSWR	A	25, 85	1.01	1.68:1	2.3:1	-
RF Output Return Loss	TXM_ORL	A	25, 85	8.09	12	-	dB
RF Output 1dB Compression (Note 3)	$V_{CC} = 5.5V$ TXM_P1DH	A	25, 85	-10	-7.5	-	dBm
RF Output Third Order Intercept	TXM_IP3	C	25	-	-1.0	-	dBm
Transmit Mixer Noise Figure	TXM_NF	B	25	-	18	-	dB

**Electrical Specifications**  $V_{CC} = 5.5V$ , LO = 2400MHz, IF = 100MHz, RF = 2500MHz,  $Z_O = 50\Omega$ ,  
Unless Otherwise Specified **(Continued)**

PARAMETER	SYMBOL	(NOTE 2) TEST LEVEL	TEMP (°C)	MIN	TYP	MAX	UNITS
<b>TRANSMIT POWER PREAMP CHARACTERISTICS</b> (PRE_IN = 2400MHz/-30dBm, AGC_CTRL = 0.7V (Max Gain))							
Frequency Range	PRE_f	B	25	2.3	-	2.7	GHz
Power Gain (AGC_CTRL = 0.7V)	$V_{CC} = 5.5V$ PRE_PGH	A	25, 85	21	24	27	dB
Pre-Amp Noise Figure (Max Gain)	PRE_NF	B	25	-	8	-	dB
Pre-Amp AGC Range (Max - Min Gain)	PRE_AGC	A	25, 85	20	30	-	dB
AGC Control Voltage Range	AGC_V	A	25, 85	0.7	-	1.7	V
AGC Control Linearity	AGC_LIN	B	25	-	5:1	-	-
AGC Settling Time (Min to Max Gain)	AGC_T1	B	25	-	8.0	-	$\mu$ S
AGC Settling Time (Max to Min Gain)	AGC_T2	B	25	-	0.1	-	$\mu$ S
Pre-Amp RF Output 1dB Compression	$V_{CC} = 5.5V$ PRE_P1DH	A	25, 85	6	8	-	dBm
RF Output Third Order Intercept	PRE_IP3	C	25	-	14	-	dBm
Input VSWR	PRE_ISWR	A	25, 85	1.0:1	2.0:1	3.0:1	-
Input Return Loss	PRE_IRL	A	25, 85	6	7	-	dB
Output VSWR	PRE_OSWR	A	25, 85	1.0:1	1.28:1	2.3:1	-
Output Return Loss	PRE_ORL	A	25, 85	8.09	20	-	dB
<b>POWER SUPPLY AND LOGIC CHARACTERISTICS</b>							
Voltage Supply Range	$V_{CC}$	A	25, 85	-	5.5	-	V
Supply Current ( $V_{CC} = 5.5V$ )	$I_{CC\_HI}$	A	25, 85	90	103	110	mA
	$I_{CC\_HI}^T$	C	Full	-	-	110	mA
Power Down Supply Current ( $V_{CC} = 5.5V$ )	$I_{CC\_PD}$	A	25, 85	2	3.3	4	mA
Logic Input Low Level	$V_{IL}$	A	25, 85	-0.2	-	0.8	V
Logic Input High Level	$V_{IH}$	A	25, 85	2.0	-	$V_{CC}$	V
Logic Low Input Bias Current ( $V_{PE} = 0V$ , $V_{CC} = 5.5V$ )	$I_{B\_LO}$	A	25, 85	-5	-0.1	5	$\mu$ A
Logic High Input Bias Current ( $V_{PE} = 5.5V$ , $V_{CC} = 5.5V$ )	$I_{B\_HI}$	A	25, 85	-5	0.6	5	$\mu$ A
Vagc High Input Bias Current ( $V_{agc} = 2.1V$ , $V_{CC} = 5.5V$ )	$I_{vagc\_HI}$	A	25, 85	10	200	400	$\mu$ A
Vagc Low Input Bias Current ( $V_{agc} = 0.7V$ , $V_{CC} = 5.5V$ )	$I_{vagc\_LO}$	A	25, 85	-400	-235	-10	$\mu$ A
Power Enable Time (50% $V_{PE}$ to 90% $I_{CC}$ )	PEt	B	25	-	5	10	$\mu$ s
Power Disable Time (50% $V_{PE}$ to 10% $I_{CC}$ )	PDt	B	25	-	0.1	10	$\mu$ s

**NOTES:**

- Test Level: A = 100% production tested, B = Typical or Limit based on characterization data, C = Design information, goal or condition.
- Bias Resistor at pin 16 changes according to the relationship mentioned in Note 4 of the Typical Applications Circuit.

